

Luis Manzanillas 2024.03.27 LAPP

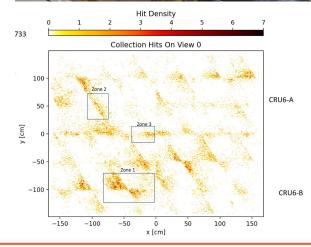




Context

- DUNE CRP anodes fabricated by gluing perforated PCBs
 - Need very good precision in hole dimension and pitch
 - Ideally we would like to have a QC/QA process to verify hole dimension and pitch in all PCBs and assembled anodes
 - Or at least samples of each anode
 - Automate process
 - Keep track of information in a database
- Cold Box test of CRP6
 - Laura analysis showed strange behaviour with reduced charge in some regions of collection view and apparent collection of charge in induction 1 view
 - What is the origin of this behaviour?

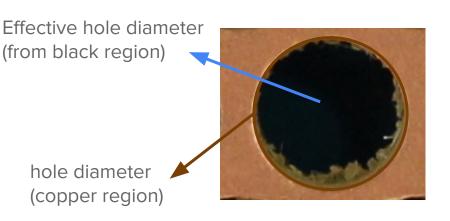


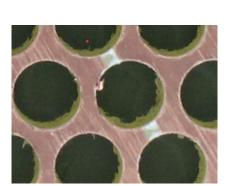




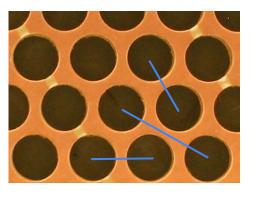
Parameters for QA/QC

- Different parameters can be studied with photo analysis
 - Hole diameter: Taking copper as reference
 - **Effective hole diameter:** "real" diameter of holes that electrons will go through, including effects of misalignment, glue/paper/copper residuals
 - **Pitch:** Distance between holes in a given direction
 - Cu and drilling quality





Bad Cu/drilling quality

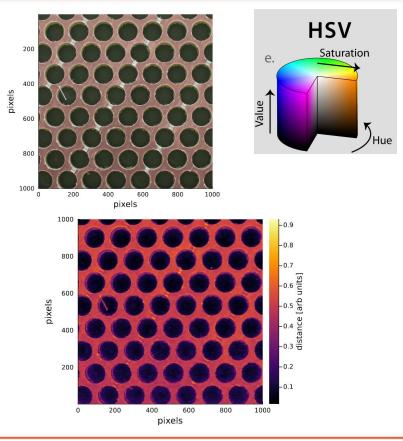


Pitch

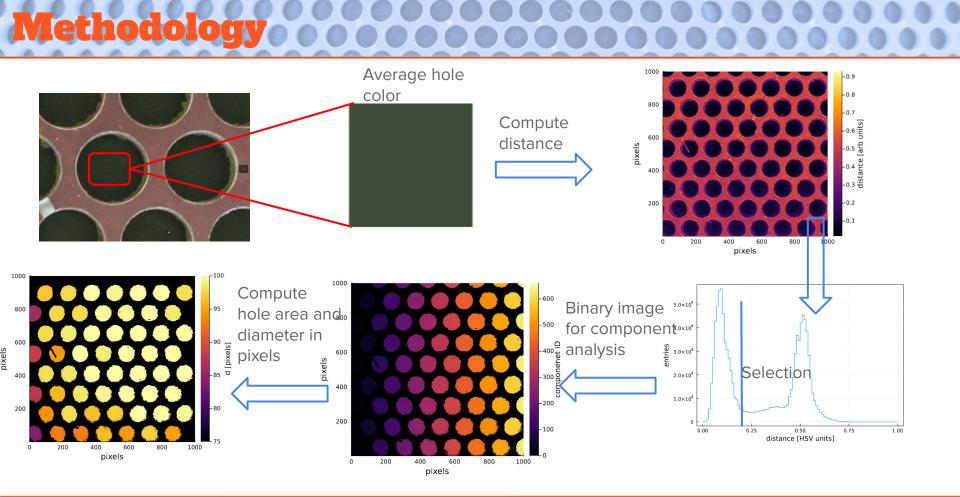


Methodology

- Images/photos can be converted to HSV color space (cylindrical coordinates)
- PCBs have regular structure that can be used to identify components by using the different colors (copper, glue, etc)
 - Different parts (holes, copper, glue) can be separated defining a metric (distance in HSV space) to a reference color (copper, glue, paper on background, etc)
 - Once holes are identified the area/diameter of each hole can be calculated (in pixels)
 - The center of the holes can be used to measure the pitch

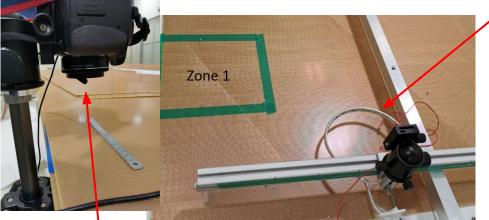






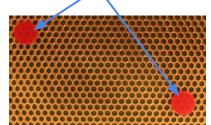


The setup



Dominique's camera: CANON APSC (3456 x 5184) pixels 24 mm LENS in macro mode Lens geometrical correction applied by Dominique using dedicated image software (rawtherapee) Need uniform light to improve precision: Using **Chris M. idea/setup** of ring of LEDs around camera

Black coverage to reduce light variations from clean room illumination 10 mm diameter red circles for pixel to mm calibration factor

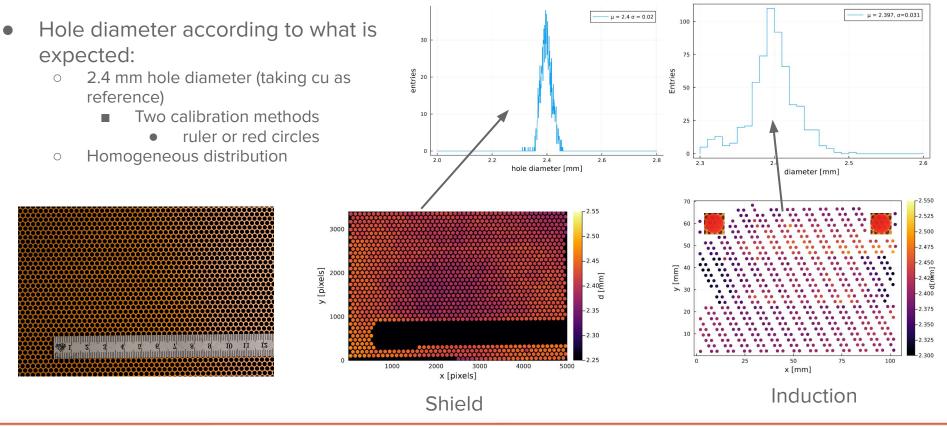


Several photo-taking campaigns performed by Dominique, Luis, Chris...



+

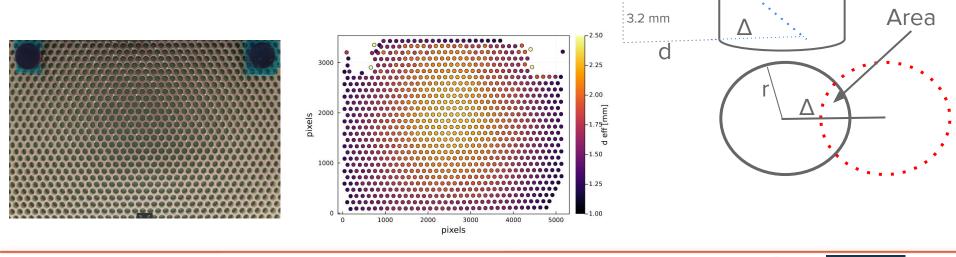
Results CRP7 - hole diamet





Results CRP7 - effective hole d

- Camera is placed above center of each photo
 - Shadow effect if go far away from the center
 - Given by distance of camera to anode and anode thickness
 - To look for small effects a correction is needed

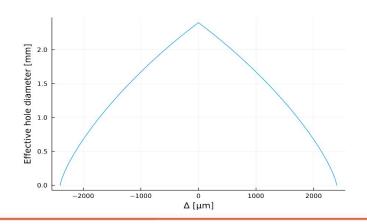


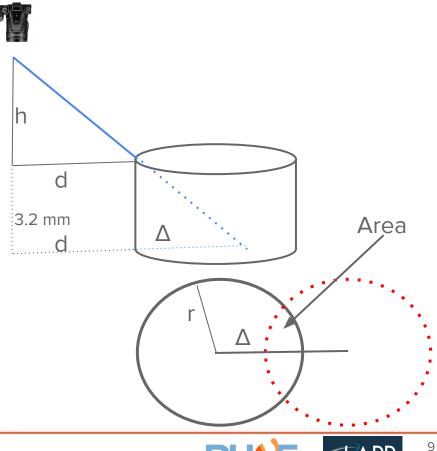
h

d

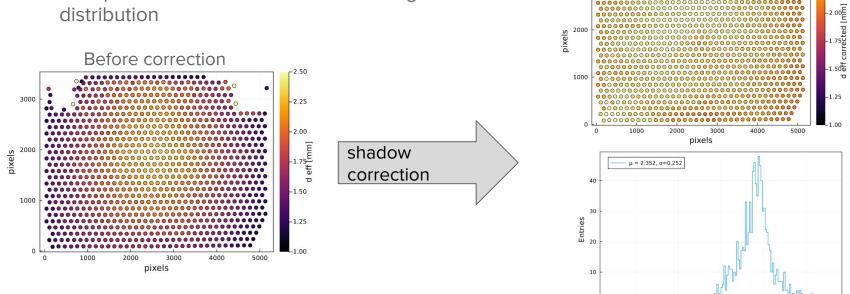


- The expected area is given by intersection of two circles
 - Area = $2*r^2*acos(\Delta/2*r) \Delta*sqrt(r^2 (\Delta/2)^2)$ Ο
 - with $\Delta = (Anode_tickness/h)^*d$ Ο
 - Correction: $sqrt(Area/(\pi r^2))$ 0
 - The same effect is produced by a real shift of Ο the two glued PCBs
 - In this case dependence of only Δ





- Introduce a correction as described in previous slide
- If no problem we should have a "homogenous distribution





2.4

2.7

2.1

Eff hole diamter [mm]

nfran a an all crfra

1.8

1.5

After correction

0 3000 0

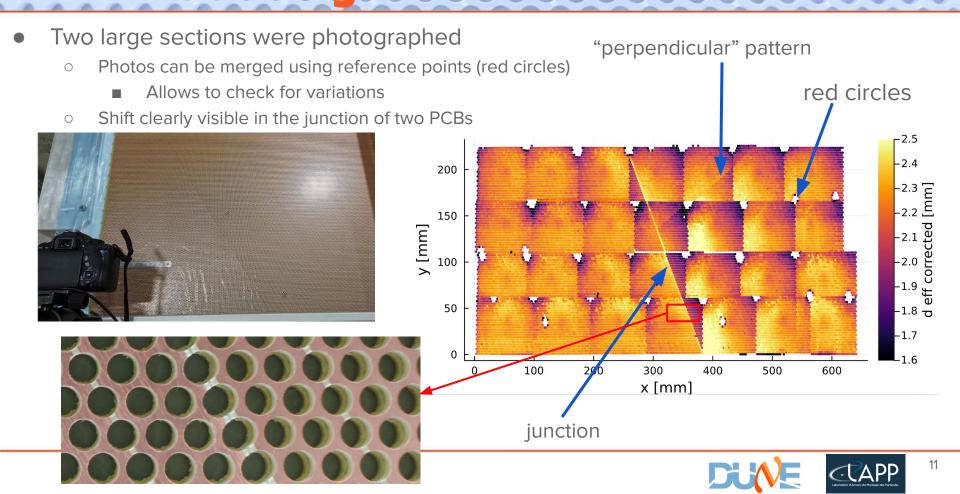
00 0

-2.50

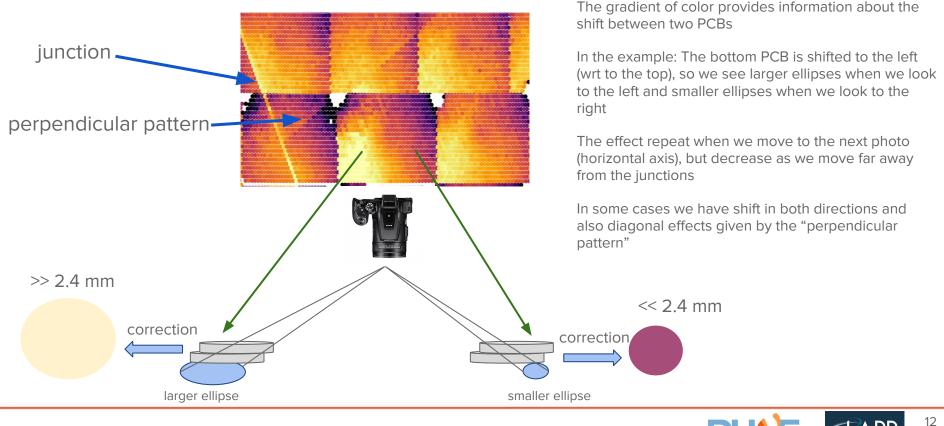
-2.25

0

sults in a large area



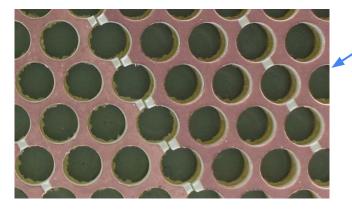
Observed effects

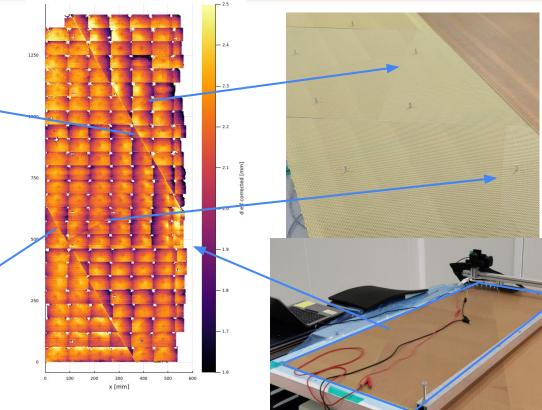




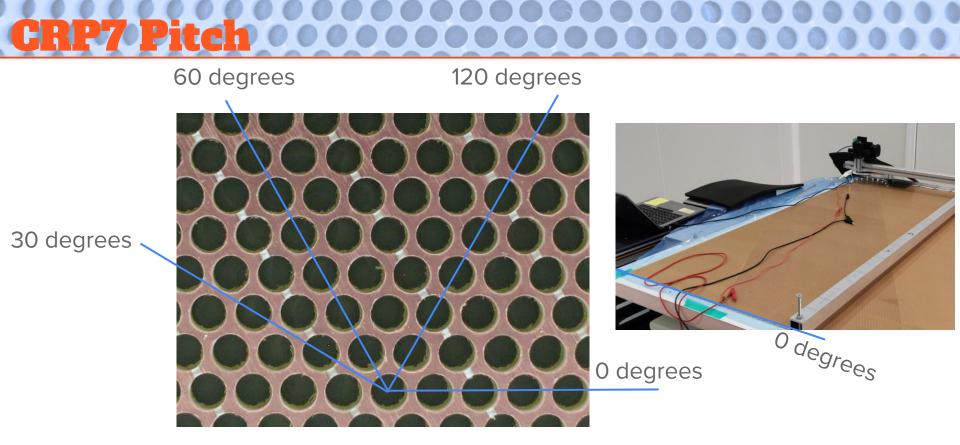
Results large area 2





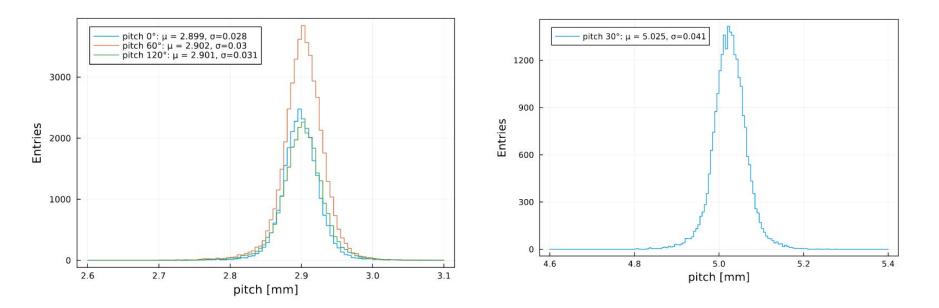








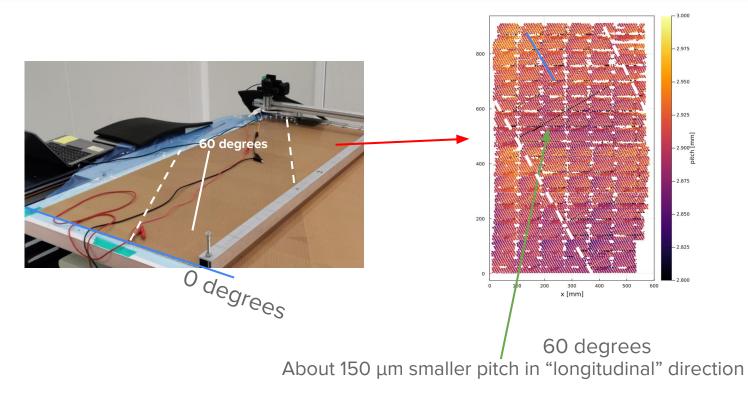
Pitch distribution



In general homogeneous everywhere



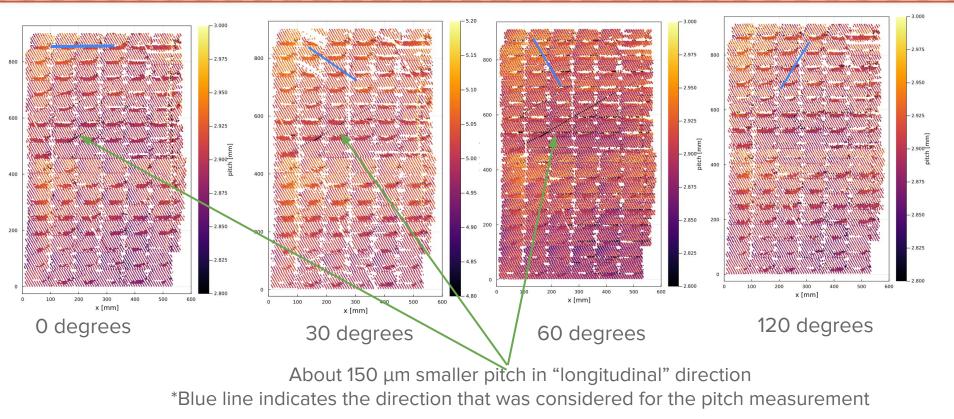
Pitch over large area





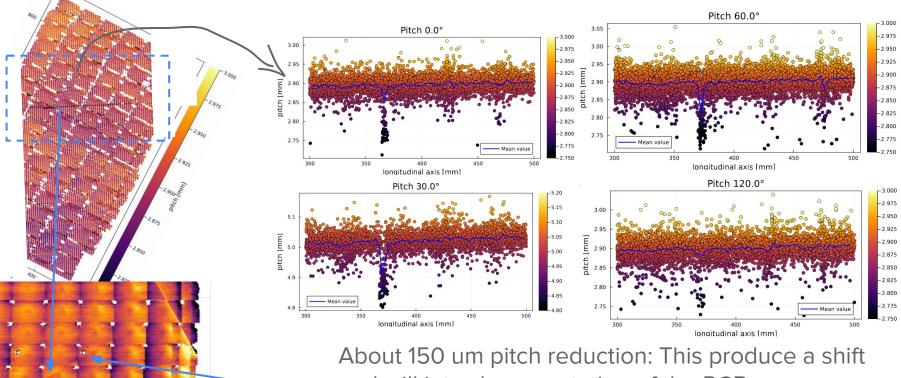
CLAPP

Pitch over large area





Pitch variations



and will introduce a rotation of the PCBs Can we see this effect in the photos?

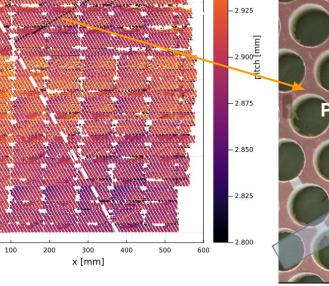


500

Effective hole

ameter

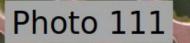
- 3.000 Photo 111 2.975 800 - 2.950 600 - 2.925 itch [mm] 400 - 2.875 Photo 103 - 2.850 200



0

0



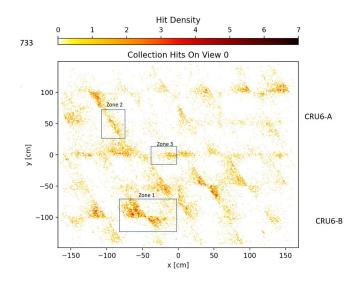


PP

STATE OF

CRP 6

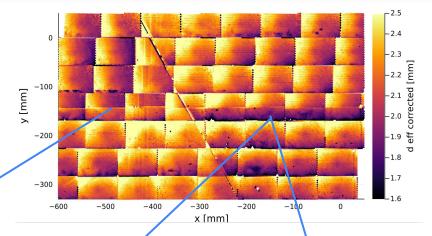
- Dominique photographed 3 regions of shield PCB of CRP 6 when suspended in Faraday cage after second cold box run
- Use analysis to confirm shift of PCBs in problematic regions



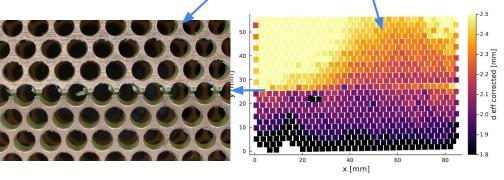




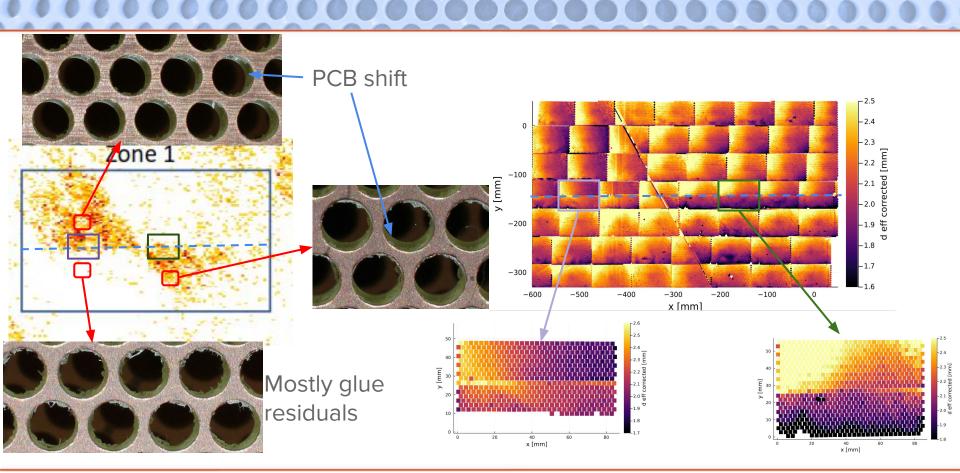
- Conditions less well controlled than when using setup in clean room
- Nevertheless:
 - A shift is clearly visible 0
 - Corresponds with pattern observed by Laura 0
 - The effective hole diameter in the worst part is 0 about 1.9 mm









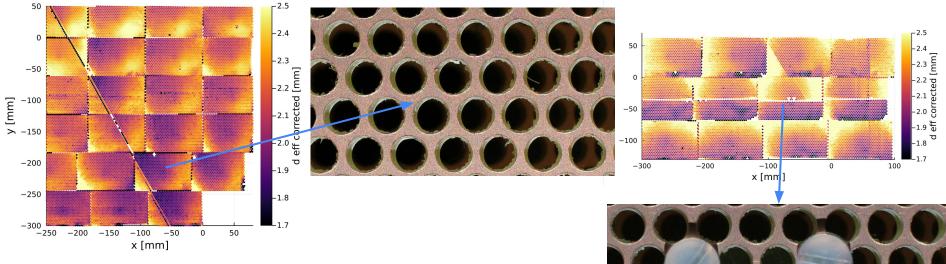




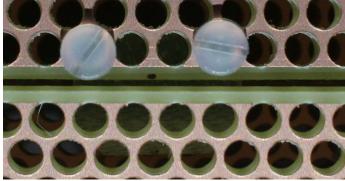


CLAPP

CRP6: Zone 2 and 3



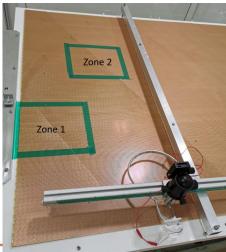
- Same effect as in Zone 1
- Shift clearly visible

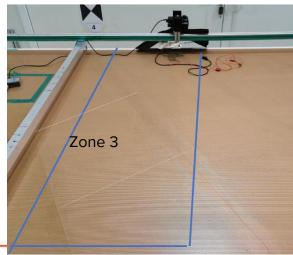




New anode for CRP6

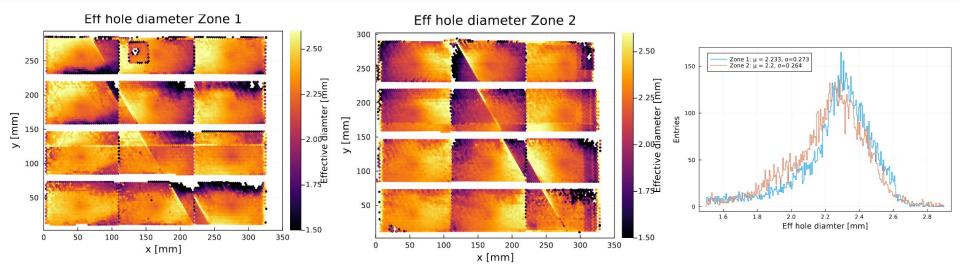
- Clear evidence that a misalignment/shift in the PCBs is at the origin of decrease of charge collection
 - It affects mostly the electron diffusion ; simulations are ongoing, first estimate by FP shows possible significant effect
 - Additional analysis ongoing by JP.
- The effect is larger in PCB junctions
 - If border of PCBs is reduced (sanded) this should reduce constraints and might improve alignment?
 - New anode builded to check effect
 - Zone 1 and 2 above junctions: shielding + induction
 - Part of Zone 2 is the continuation of PCB in Zone 3
 - Zone 3: large area allowing to check pitch variations







Effective hole diameter Zones 1 and 2

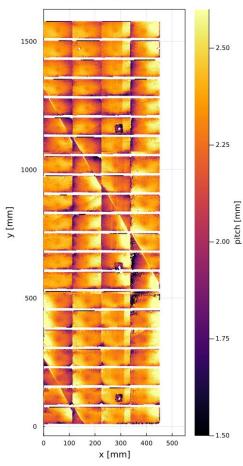


- Shift still present in both zones: Larger in Zone 2
 - Sanding the border of the PCBs seems to improve the alignment but shift still present
- Small rotation produces such a shift
 - If systematic reduced pitch (~150 um) pattern ~each 50 cm in all PCBs, then this can produce a rotation resulting in a shift (misalignment)
 - Do we have everywhere this reduced pitch pattern? -> Check Zone 3 of this new PCB to confirm effect

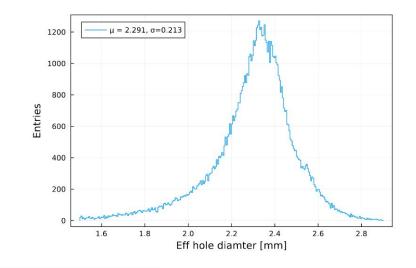


Effective hole diameter Zone 3

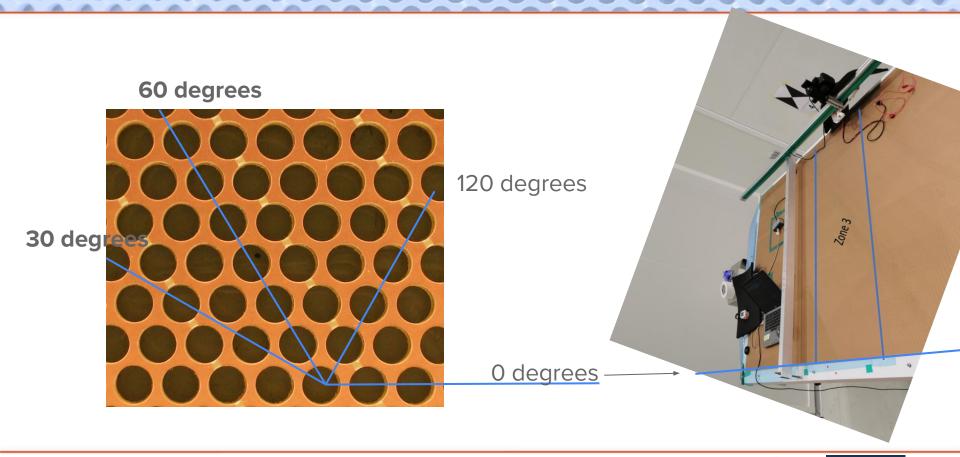
Eff hole diameter



- Most of the regions show a very homogenous response
- Some shift is present but smaller than Zones 1 and 2
 - Effect might depend on the order of gluing: more shift in the parts glued at the end?







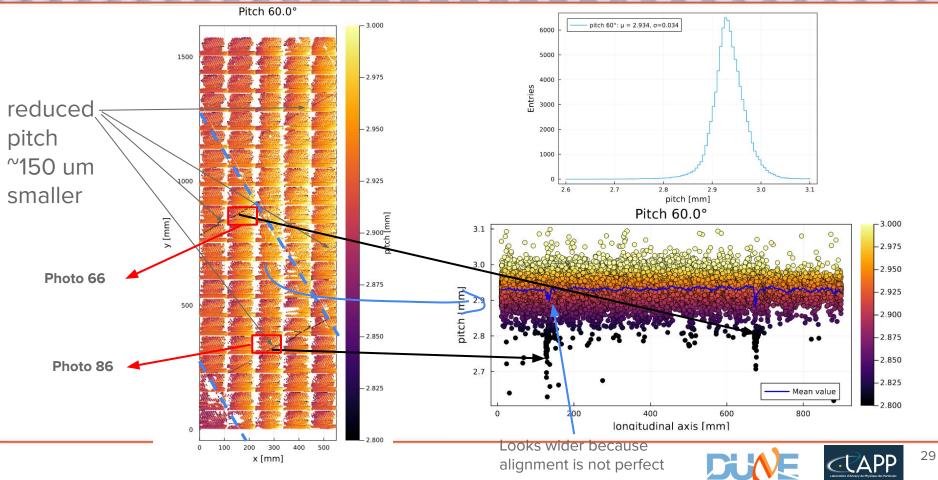
e

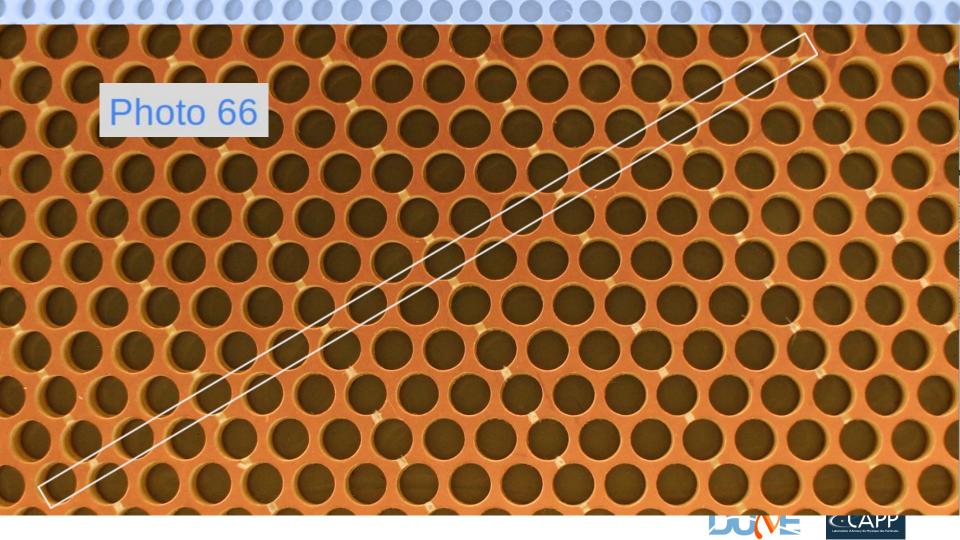
2

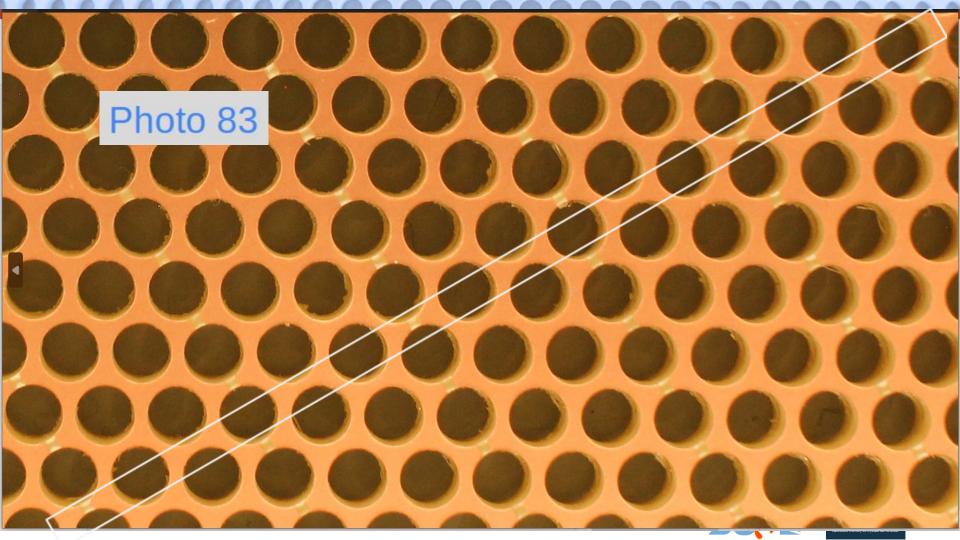
Ditch

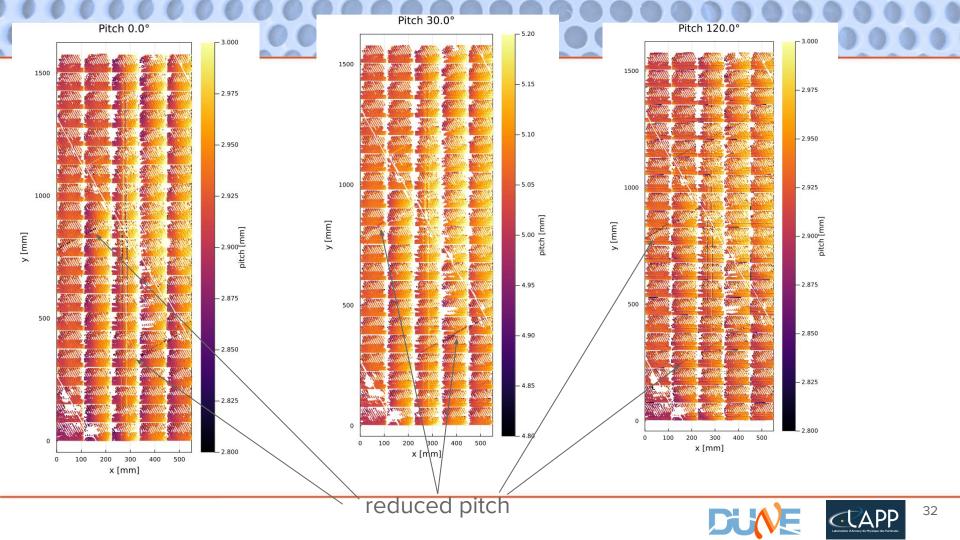


Pitch Zone 3









Conclusions

- We have developed a method for QA/QC of CRPs anodes based on analysis of photos
 - PCBs can also be checked individually before anode assembly
 - Qualitative and quantitative results have been obtained
 - Hole diameter according to specifications
- Problems observed
 - Misalignment of holes in some regions after anode assembly → reduced effective hole diameter
 - Origin most likely coming from a small rotation produced by a systematic reduced pitch pattern each 50 cm
 - Effective hole diameter also reduced by remaining glue inside the holes
- Results allowed to provide feedback to manufacturer
 - Improvement of production should solve these issues and improve quality of anodes
- QA/QC method can be improved and fully automated for full anode production

